consemi Contact Name Title - Contact Product-Env-Stewards Product Enviro Compliance Authorized Representative* Product-Env-Stewards Product-Env-Stewards Product-Enviro Compliance NA Product-Env-Stewards	ise Date*		
Company name* Company unique ID Unique ID Authority Responsessi Contact Name Title - Contact Phone - Contact* Email - Product-Env-Stewards Authorized Representative* Title - Representative Product-Enviro Compliance NA Product Phone - Representative* Email - Product-Env-Stewards Product-Enviro Compliance NA Product Product-Env-Stewards Product-Enviro Compliance NA Product Product-Env-Stewards	5-28		
nsemi Title - Contact Product-Env-Stewards Product Enviro Compliance Title - Representative Title - Representative Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Enviro Compliance NA Product-Env-Stewards Product-Enviro Compliance NA Product-Env-Stewards Product-Enviro Compliance NA Product-Env-Stewards	5-28		
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Product-Env-Stewards Product Enviro Compliance NA Product Authorized Representative* Title - Representative Phone - Representative* Email - Product-Env-Stewards Product Enviro Compliance NA Product	Contact*		
Authorized Representative* Title - Representative Product-Env-Stewards Product Enviro Compliance NA Product			
Product-Env-Stewards Product Enviro Compliance NA Product	Product-Env-Stewards@onsemi.com		
	Email - Representative*		
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site	Product-Env-Stewards@onsemi.com		
	Weight* UOM Unit Type		
FOD8343 4A GATE DRIVER 2025-05-28 LITEONFG	203.109 mg Each		
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Terminal Plating / Peak Process Body Temperature Max Time at Peak Temperature Peak Temperature Max Time at Peak Temperature Peak Temperat	uture Number of Reflow Cycles		
	105 3		
omments evel 1 - maximum time at peak temperature during soldering is 10-30 seconds			
or more information regarding material composition please refer to page 3			

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.									
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Coupling Gel 0.37	0.37	mg	Supplier	Methylhydrogen Siloxane, Trimethylsiloxy-terminated	63148-57-2		0.0185	mg	
			Supplier	Filler (SiO2)	68909-20-6		0.0555	mg	
			Supplier	Dimethyl Siloxane	68083-19-2		0.296	mg	
Die	0.099	0.099	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.033	mg
			Supplier	Silicon (Si)	7440-21-3		0.066	mg	
Die Attach	0.092	mg	Supplier	Silver (Ag)	7440-22-4		0.0754	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0166	mg	
Lead Frame	35.26	35.26	mg	Supplier	Silver (Ag)	7440-22-4		0.1763	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0317	mg	
			Supplier	Iron (Fe)	7439-89-6		0.7405	mg	
			Supplier	Copper (Cu)	7440-50-8		34.2798	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0317	mg	
fold Compound-Black 125.0	125.09	125.09 mg	В	Brominated Bisphenol A Diglycidyl Ether	r 40039-93-8		2.5018	mg	
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.8763	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.6254	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		88.8139	mg	
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		21.8907	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		9.3818	mg	
Mold Compound-White 39.44	39.44	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		7.888	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		27.608	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.944	mg	
Plating	0.36	mg	Supplier	Tin (Sn)	7440-31-5		0.36	mg	
Wire Bond - Au	2.398	mg	Supplier	Gold (Au)	7440-57-5		2.398	mg	